

# RF Power LDMOS Transistors

## N-Channel Enhancement-Mode Lateral MOSFETs

RF power transistors designed for applications operating at frequencies between 1200 and 1400 MHz, 1% to 12% duty cycle. These devices are suitable for use in pulse applications, such as L-Band radar.

- Typical Pulse Performance:  $V_{DD} = 50 \text{ Vdc}$ ,  $I_{DQ} = 150 \text{ mA}$ ,  $P_{out} = 330 \text{ W Peak (39.6 W Avg.)}$ ,  $f = 1400 \text{ MHz}$ , Pulse Width = 300  $\mu\text{sec}$ , Duty Cycle = 12%  
Power Gain — 18 dB  
Drain Efficiency — 60.5%
- Capable of Handling 5:1 VSWR @ 50 Vdc, 1400 MHz, 330 W Peak Power

### Features

- Characterized with Series Equivalent Large-Signal Impedance Parameters
- Internally Matched for Ease of Use
- Qualified Up to a Maximum of 50 V<sub>DD</sub> Operation
- Integrated ESD Protection
- Greater Negative Gate-Source Voltage Range for Improved Class C Operation
- In Tape and Reel. R5 Suffix = 50 Units, 56 mm Tape Width, 13-inch Reel.

**MMRF1011HR5**  
**MMRF1011HSR5**

**1400 MHz, 330 W, 50 V**  
**PULSE L-BAND**  
**RF POWER MOSFETs**

**NI-780H-2L**  
**MMRF1011HR5**

**NI-780S-2L**  
**MMRF1011HSR5**

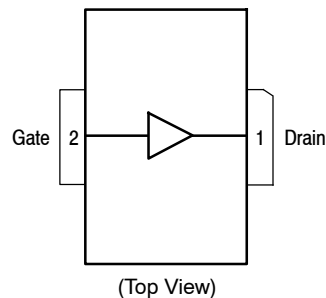
**Table 1. Maximum Ratings**

| Rating                               | Symbol    | Value       | Unit |
|--------------------------------------|-----------|-------------|------|
| Drain-Source Voltage                 | $V_{DSS}$ | -0.5, +100  | Vdc  |
| Gate-Source Voltage                  | $V_{GS}$  | -6.0, +10   | Vdc  |
| Storage Temperature Range            | $T_{stg}$ | -65 to +150 | °C   |
| Case Operating Temperature           | $T_C$     | 150         | °C   |
| Operating Junction Temperature (1,2) | $T_J$     | 225         | °C   |

**Table 2. Thermal Characteristics**

| Characteristic                                                                                                             | Symbol          | Value (2,3) | Unit |
|----------------------------------------------------------------------------------------------------------------------------|-----------------|-------------|------|
| Thermal Resistance, Junction to Case<br>Case Temperature 65°C, 330 W Peak, 300 $\mu\text{sec}$ Pulse Width, 12% Duty Cycle | $Z_{\theta JC}$ | 0.13        | °C/W |

- Continuous use at maximum temperature will affect MTTF.
- MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.
- Refer to AN1955, *Thermal Measurement Methodology of RF Power Amplifiers*. Go to <http://www.freescale.com/rf>. Select Documentation/Application Notes - AN1955.



**Figure 1. Pin Connections**

**Table 3. ESD Protection Characteristics**

| Test Methodology                      | Class |
|---------------------------------------|-------|
| Human Body Model (per JESD22-A114)    | 1C    |
| Machine Model (per EIA/JESD22-A115)   | A     |
| Charge Device Model (per JESD22-C101) | IV    |

**Table 4. Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|----------------|--------|-----|-----|-----|------|
|----------------|--------|-----|-----|-----|------|

**Off Characteristics**

|                                                                                                   |               |     |   |     |                 |
|---------------------------------------------------------------------------------------------------|---------------|-----|---|-----|-----------------|
| Gate-Source Leakage Current<br>( $V_{GS} = 5\text{ Vdc}$ , $V_{DS} = 0\text{ Vdc}$ )              | $I_{GSS}$     | —   | — | 10  | $\mu\text{Adc}$ |
| Drain-Source Breakdown Voltage<br>( $V_{GS} = 0\text{ Vdc}$ , $I_D = 100\text{ mA}$ )             | $V_{(BR)DSS}$ | 100 | — | —   | Vdc             |
| Zero Gate Voltage Drain Leakage Current<br>( $V_{DS} = 50\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ ) | $I_{DSS}$     | —   | — | 50  | $\mu\text{Adc}$ |
| Zero Gate Voltage Drain Leakage Current<br>( $V_{DS} = 90\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc}$ ) | $I_{DSS}$     | —   | — | 2.5 | mA              |

**On Characteristics**

|                                                                                                               |              |     |      |     |     |
|---------------------------------------------------------------------------------------------------------------|--------------|-----|------|-----|-----|
| Gate Threshold Voltage<br>( $V_{DS} = 10\text{ Vdc}$ , $I_D = 662\text{ }\mu\text{Adc}$ )                     | $V_{GS(th)}$ | 0.9 | 1.6  | 2.4 | Vdc |
| Gate Quiescent Voltage<br>( $V_{DD} = 50\text{ Vdc}$ , $I_D = 150\text{ mAdc}$ , Measured in Functional Test) | $V_{GS(Q)}$  | 1.5 | 2.4  | 3   | Vdc |
| Drain-Source On-Voltage<br>( $V_{GS} = 10\text{ Vdc}$ , $I_D = 1.63\text{ Adc}$ )                             | $V_{DS(on)}$ | —   | 0.26 | —   | Vdc |

**Dynamic Characteristics <sup>(1)</sup>**

|                                                                                                                       |           |   |     |   |    |
|-----------------------------------------------------------------------------------------------------------------------|-----------|---|-----|---|----|
| Reverse Transfer Capacitance<br>( $V_{DS} = 50\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$ ) | $C_{rss}$ | — | 0.6 | — | pF |
| Output Capacitance<br>( $V_{DS} = 50\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz, $V_{GS} = 0\text{ Vdc}$ )           | $C_{oss}$ | — | 350 | — | pF |
| Input Capacitance<br>( $V_{DS} = 50\text{ Vdc}$ , $V_{GS} = 0\text{ Vdc} \pm 30\text{ mV(rms)ac}$ @ 1 MHz)            | $C_{iss}$ | — | 330 | — | pF |

**Functional Tests** (In Freescale Test Fixture, 50 ohm system)  $V_{DD} = 50\text{ Vdc}$ ,  $I_{DQ} = 150\text{ mA}$ ,  $P_{out} = 330\text{ W Peak}$  (39.6 W Avg.),  $f = 1400\text{ MHz}$ , Pulsed, 300  $\mu\text{sec}$  Pulse Width, 12% Duty Cycle

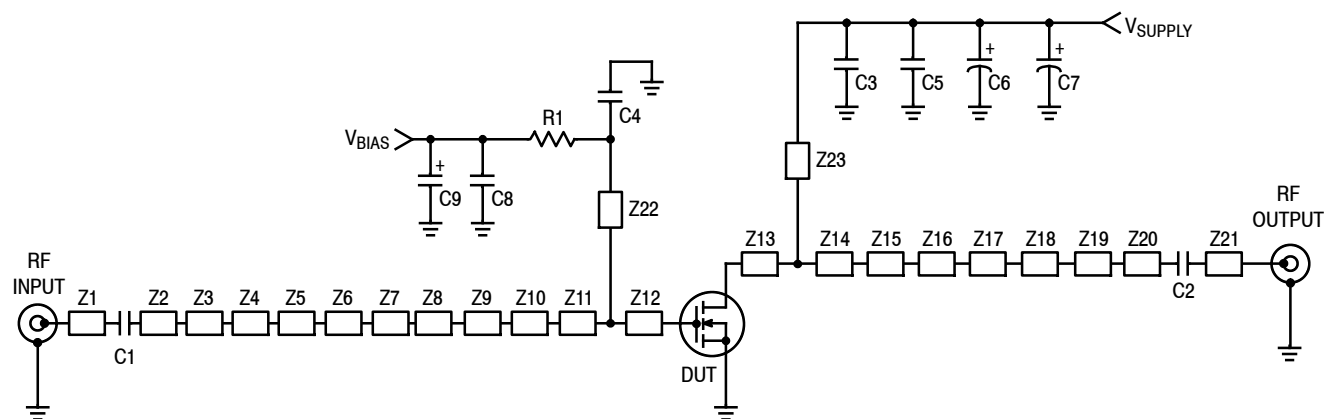
|                   |          |                   |                     |      |    |
|-------------------|----------|-------------------|---------------------|------|----|
| Power Gain        | $G_{ps}$ | 16.5              | 18                  | 19.5 | dB |
| Drain Efficiency  | $\eta_D$ | 59 <sup>(2)</sup> | 60.5 <sup>(2)</sup> | —    | %  |
| Input Return Loss | IRL      | —                 | -12                 | -9   | dB |

**Pulse RF Performance** (In Freescale Application Test Fixture, 50 ohm system)  $V_{DD} = 50\text{ Vdc}$ ,  $I_{DQ} = 150\text{ mA}$ ,  $P_{out} = 330\text{ W Peak}$  (39.6 W Avg.),  $f_1 = 1200\text{ MHz}$ ,  $f_2 = 1300\text{ MHz}$  and  $f_3 = 1400\text{ MHz}$ , 300  $\mu\text{sec}$  Pulse Width, 12% Duty Cycle,  $t_r = 50\text{ ns}$

|                                                             |                |                                |     |   |     |
|-------------------------------------------------------------|----------------|--------------------------------|-----|---|-----|
| Relative Insertion Phase                                    | $ \Delta\Phi $ | —                              | 10  | — | °   |
| Gain Flatness                                               | $G_F$          | —                              | 0.5 | — | dB  |
| Pulse Amplitude Droop                                       | $D_{rp}$       | —                              | 0.3 | — | dB  |
| Harmonic 2nd and 3rd                                        | H2 & H3        | —                              | -20 | — | dBc |
| Spurious Response                                           |                | —                              | -65 | — | dBc |
| Load Mismatch Stability<br>(VSWR = 3:1 at all Phase Angles) | VSWR-S         | All Spurs Below -60 dBc        |     |   |     |
| Load Mismatch Tolerance<br>(VSWR = 5:1 at all Phase Angles) | VSWR-T         | No Degradation in Output Power |     |   |     |

1. Part internally matched both on input and output.

2. Drain efficiency is calculated by:  $\eta_D = \frac{100 \times P_{out}}{V_{DD} \times I_{peak}}$  where:  $I_{peak} = (I_{AVG} - I_{DQ}) / \text{Duty Cycle (\%)} + I_{DQ}$ .



|     |                            |     |                                                            |
|-----|----------------------------|-----|------------------------------------------------------------|
| Z1  | 0.205" x 0.080" Microstrip | Z13 | 0.110" x 0.866" Microstrip                                 |
| Z2  | 0.721" x 0.022" Microstrip | Z14 | 0.630" x 0.866" Microstrip                                 |
| Z3  | 0.080" x 0.104" Microstrip | Z15 | 0.307" x 0.470" Microstrip                                 |
| Z4  | 0.128" x 0.022" Microstrip | Z16 | 0.045" x 0.221" Microstrip                                 |
| Z5  | 0.062" x 0.134" Microstrip | Z17 | 0.171" x 0.136" Microstrip                                 |
| Z6  | 0.440" x 0.022" Microstrip | Z18 | 0.120" x 0.430" Microstrip                                 |
| Z7  | 0.262" x 0.496" Microstrip | Z19 | 0.964" x 0.136" Microstrip                                 |
| Z8  | 0.030" x 0.138" Microstrip | Z20 | 0.177" x 0.078" Microstrip                                 |
| Z9  | 0.256" x 0.028" Microstrip | Z21 | 0.215" x 0.078" Microstrip                                 |
| Z10 | 0.058" x 0.254" Microstrip | Z22 | 1.577" x 0.070" Microstrip                                 |
| Z11 | 0.344" x 0.087" Microstrip | Z23 | 1.459" x 0.070" Microstrip                                 |
| Z12 | 0.110" x 0.087" Microstrip | PCB | Arlon CuClad 250GX-0300-55-22, 0.030", $\epsilon_r = 2.55$ |

**Figure 2. MMRF1011HR5(HSR5) Test Circuit Schematic**

**Table 5. MMRF1011HR5(HSR5) Test Circuit Component Designations and Values**

| Part | Description                              | Part Number        | Manufacturer |
|------|------------------------------------------|--------------------|--------------|
| C1   | 43 pF Chip Capacitor                     | ATC100B430JT500XT  | ATC          |
| C2   | 18 pF Chip Capacitor                     | ATC100B180JT500XT  | ATC          |
| C3   | 33 pF Chip Capacitor                     | ATC100B330JT500XT  | ATC          |
| C4   | 27 pF Chip Capacitor                     | ATC100B270JT500XT  | ATC          |
| C5   | 2.2 $\mu$ F, 100 V Chip Capacitor        | 2225X7R225KT3AB    | ATC          |
| C6   | 470 $\mu$ F, 63 V Electrolytic Capacitor | EMVY630GTR471MMH0S | Multicomp    |
| C7   | 330 pF, 63 V Electrolytic Capacitor      | EMVY630GTR331MMH0S | Multicomp    |
| C8   | 0.1 $\mu$ F, 35 V Chip Capacitor         | CDR33BX104AKYS     | Kemet        |
| C9   | 10 $\mu$ F, 35 V Tantalum Capacitor      | T491D106K035AT     | Kemet        |
| R1   | 10 $\Omega$ , 1/4 W Chip Resistor        | CRCW120610R0FKEA   | Vishay       |

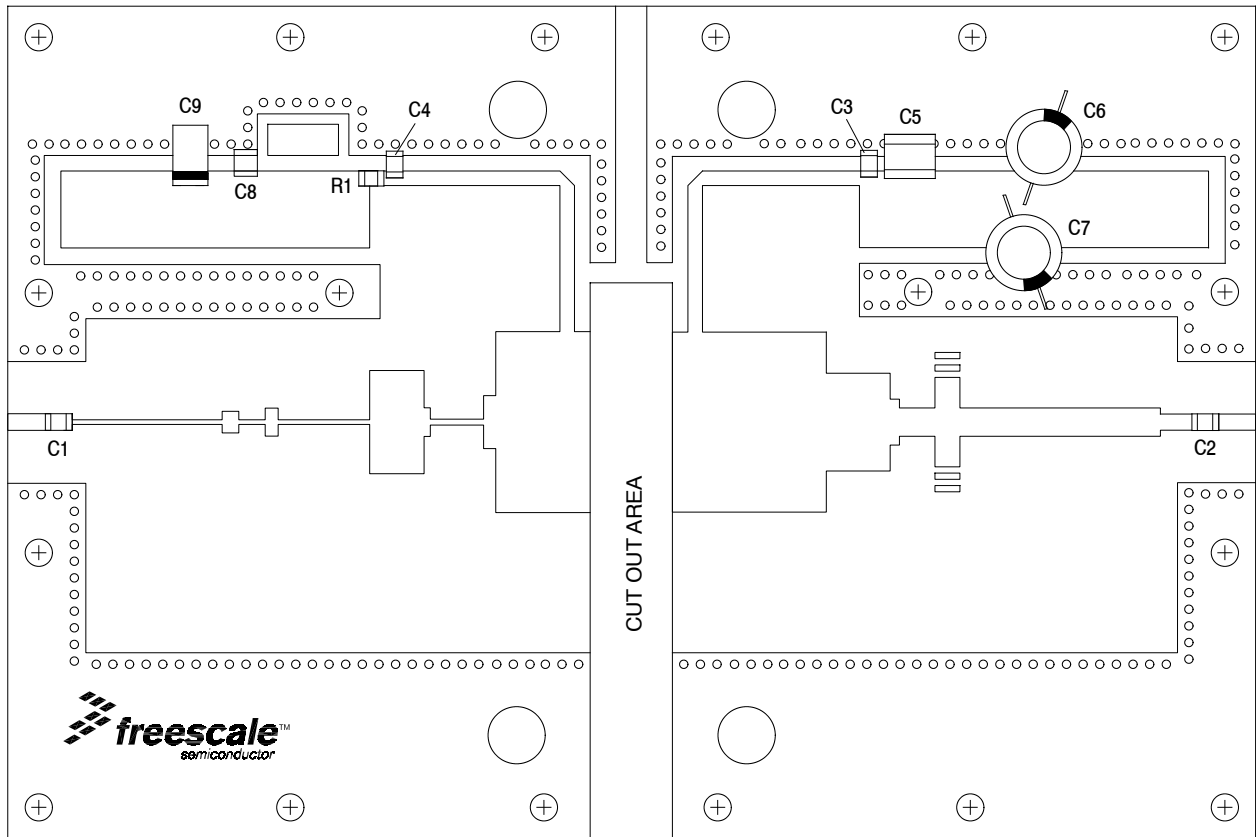


Figure 3. MMRF1011HR5(HSR5) Test Circuit Component Layout

## TYPICAL CHARACTERISTICS

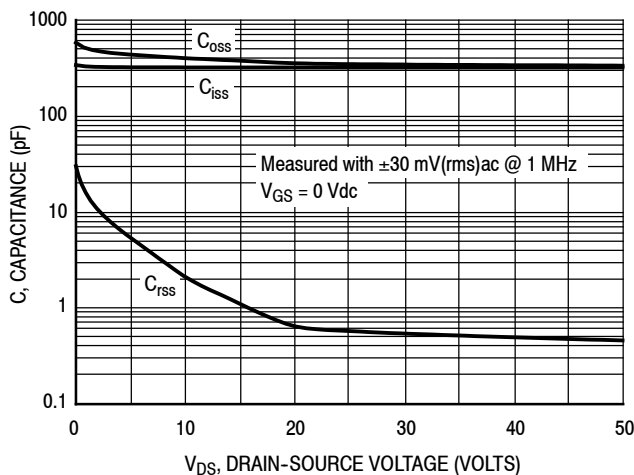


Figure 4. Capacitance versus Drain-Source Voltage

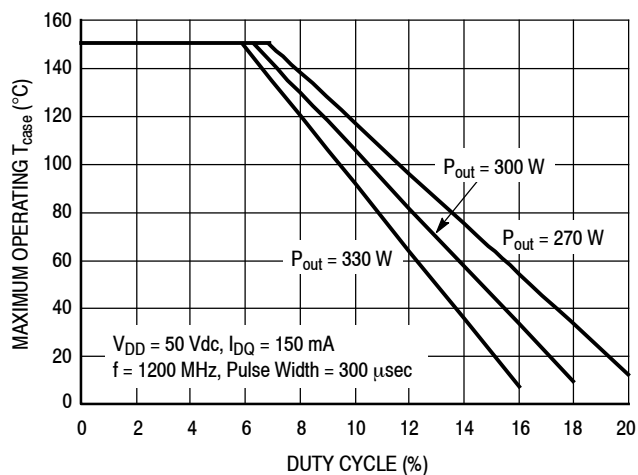


Figure 5. Safe Operating Area

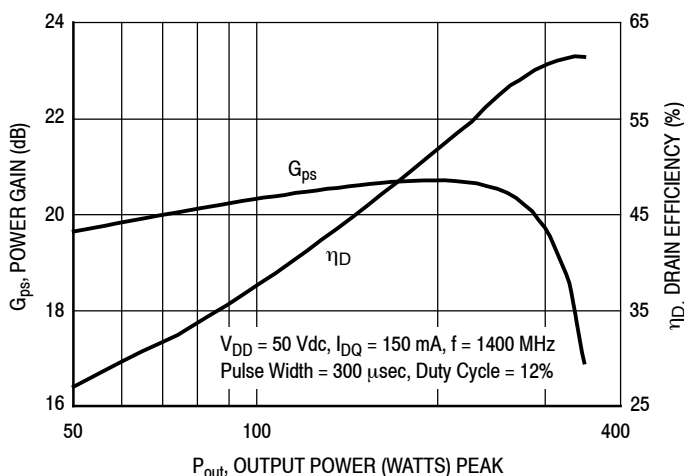


Figure 6. Power Gain and Drain Efficiency versus Output Power

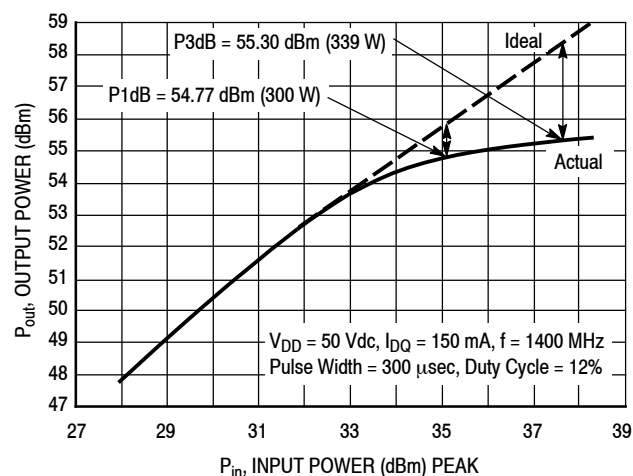


Figure 7. Output Power versus Input Power

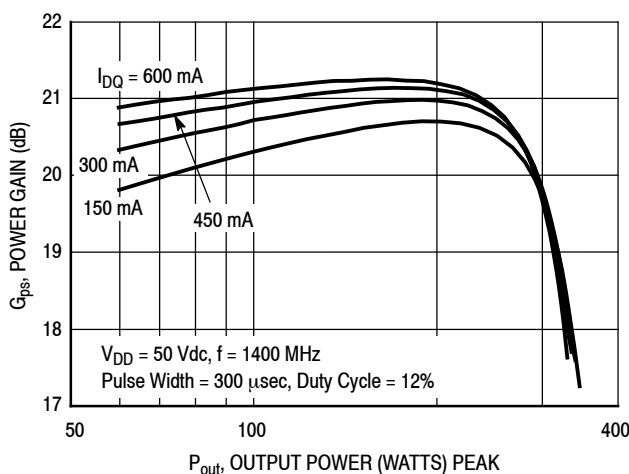


Figure 8. Power Gain versus Output Power

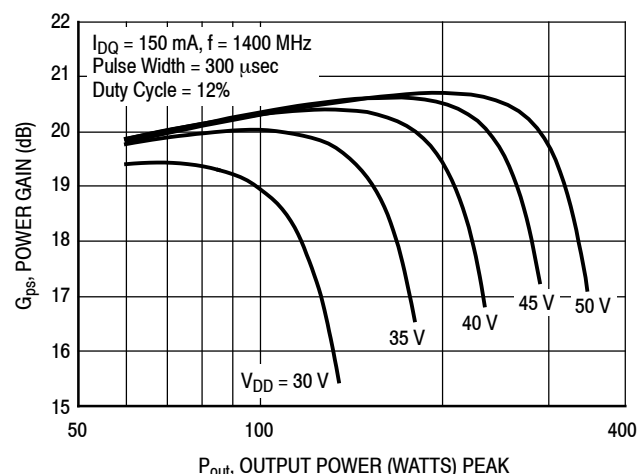


Figure 9. Power Gain versus Output Power

## TYPICAL CHARACTERISTICS

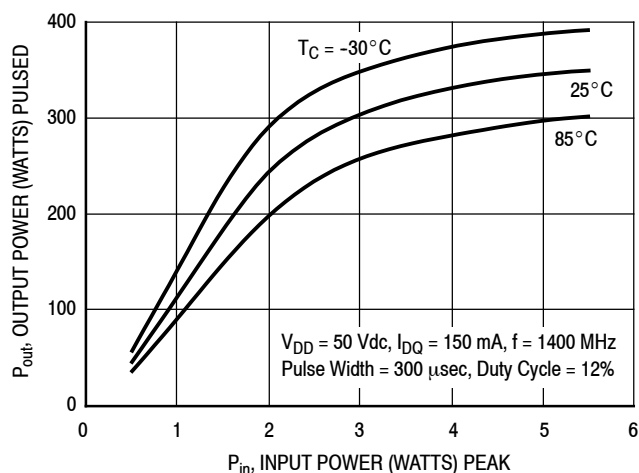


Figure 10. Output Power versus Input Power

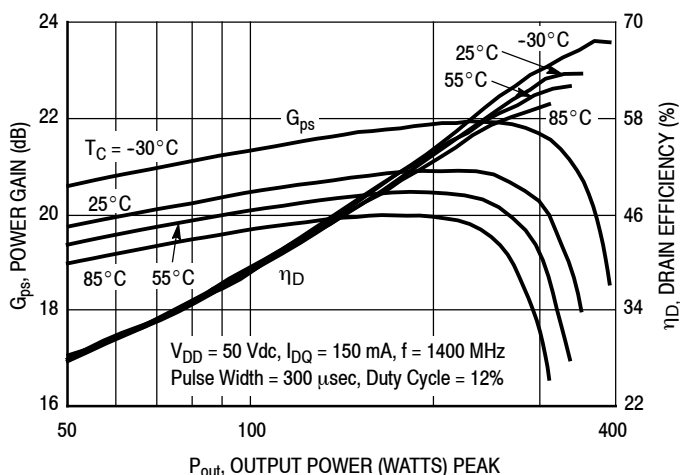


Figure 11. Power Gain and Drain Efficiency versus Output Power

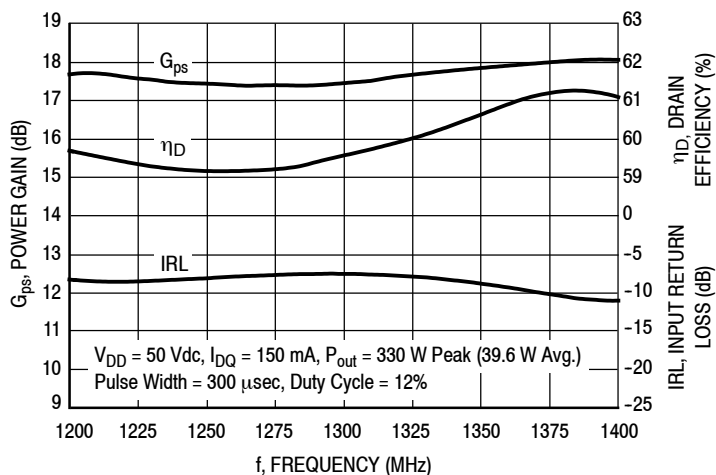
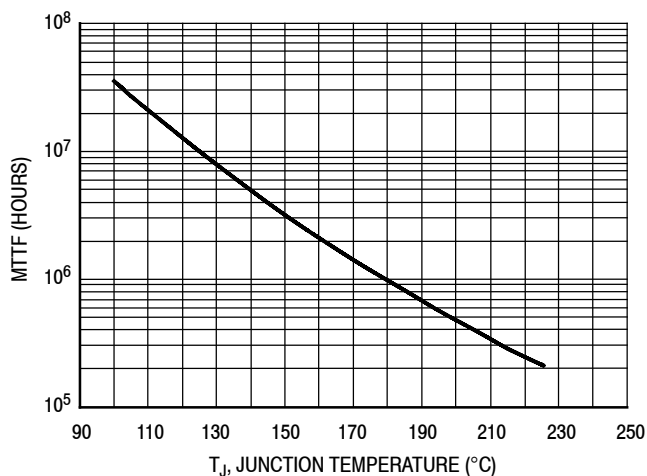


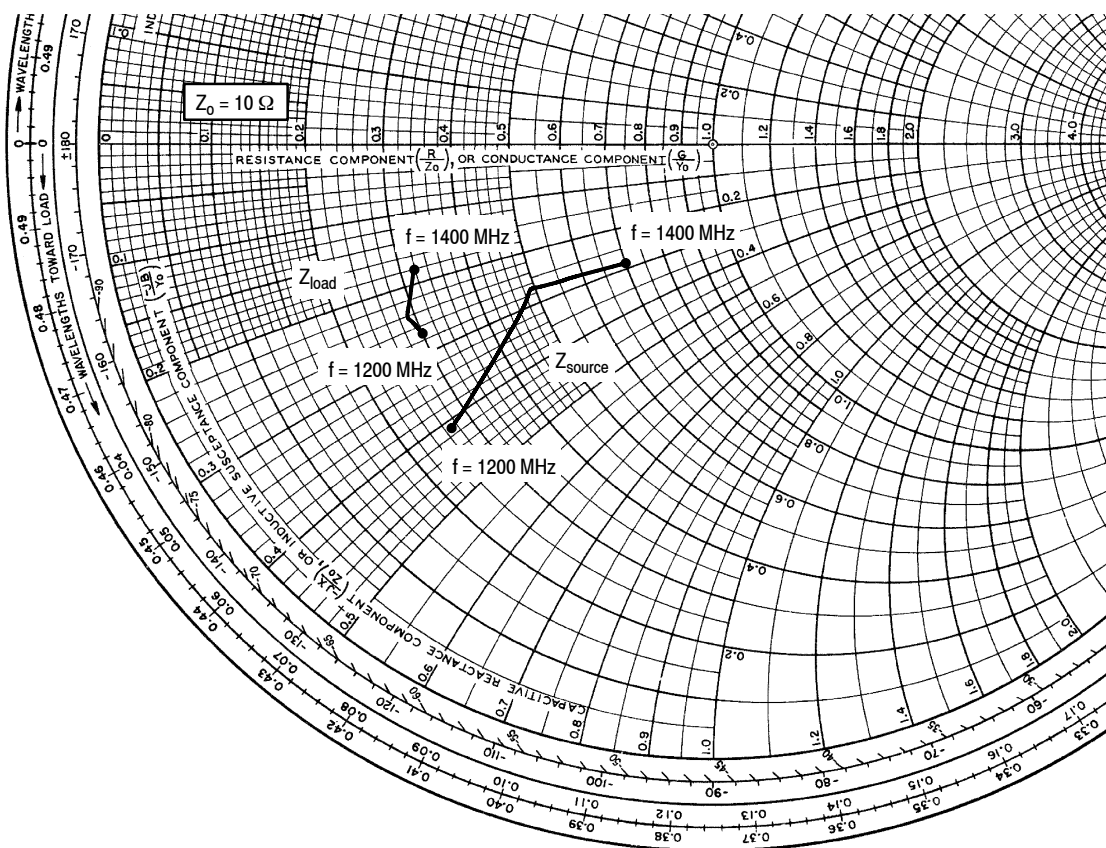
Figure 12. Broadband Performance @  $P_{out} = 330$  Watts Peak



This above graph displays calculated MTTF in hours when the device is operated at  $V_{DD} = 50$  Vdc,  $P_{out} = 330$  W Peak, Pulse Width = 300  $\mu$ sec, Duty Cycle = 12%, and  $\eta_D = 60.5\%$ .

MTTF calculator available at <http://www.freescale.com/rf>. Select Software & Tools/Development Tools/Calculators to access MTTF calculators by product.

Figure 13. MTTF versus Junction Temperature



$V_{DD} = 50 \text{ Vdc}$ ,  $I_{DQ} = 150 \text{ mA}$ ,  $P_{out} = 330 \text{ W Peak}$

| f<br>MHz | $Z_{source}$<br>$\Omega$ | $Z_{load}$<br>$\Omega$ |
|----------|--------------------------|------------------------|
| 1200     | $2.70 - j4.10$           | $2.97 - j2.66$         |
| 1300     | $4.93 - j2.66$           | $2.85 - j2.40$         |
| 1400     | $7.01 - j2.87$           | $3.17 - j1.78$         |

$Z_{source}$  = Test circuit impedance as measured from gate to ground.

$Z_{load}$  = Test circuit impedance as measured from drain to ground.

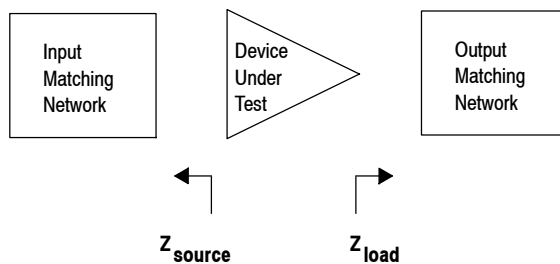
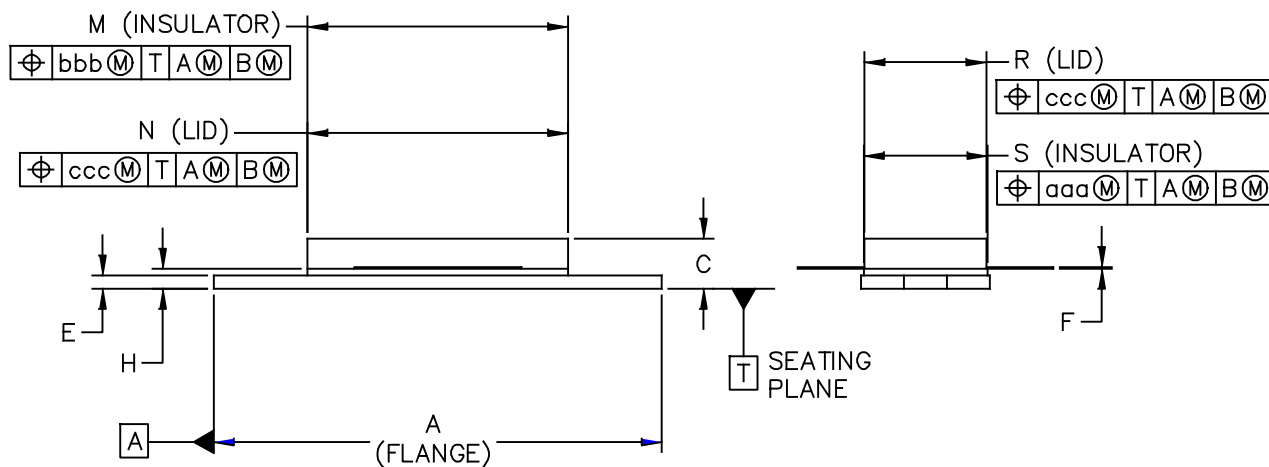
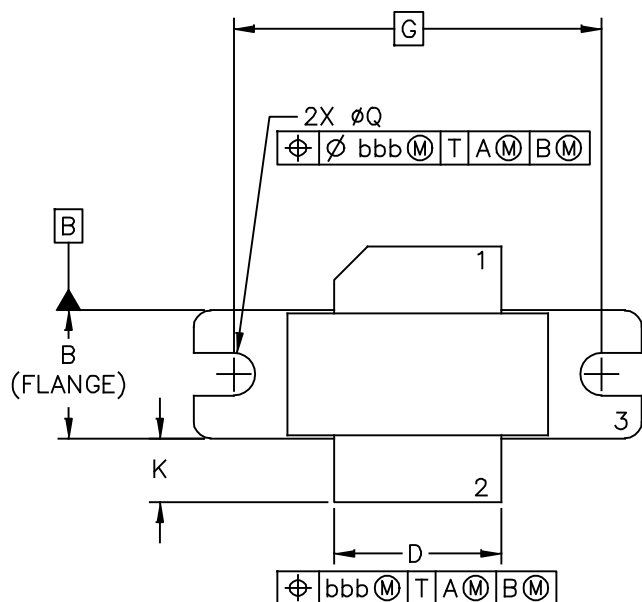


Figure 14. Series Equivalent Source and Load Impedance

# PACKAGE DIMENSIONS



|                                                         |  |                          |                            |
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| TITLE:<br><br>NI-780                                    |  | DOCUMENT NO: 98ASB15607C | REV: G                     |
|                                                         |  | CASE NUMBER: 465-06      | 31 MAR 2005                |
|                                                         |  | STANDARD: NON-JEDEC      |                            |



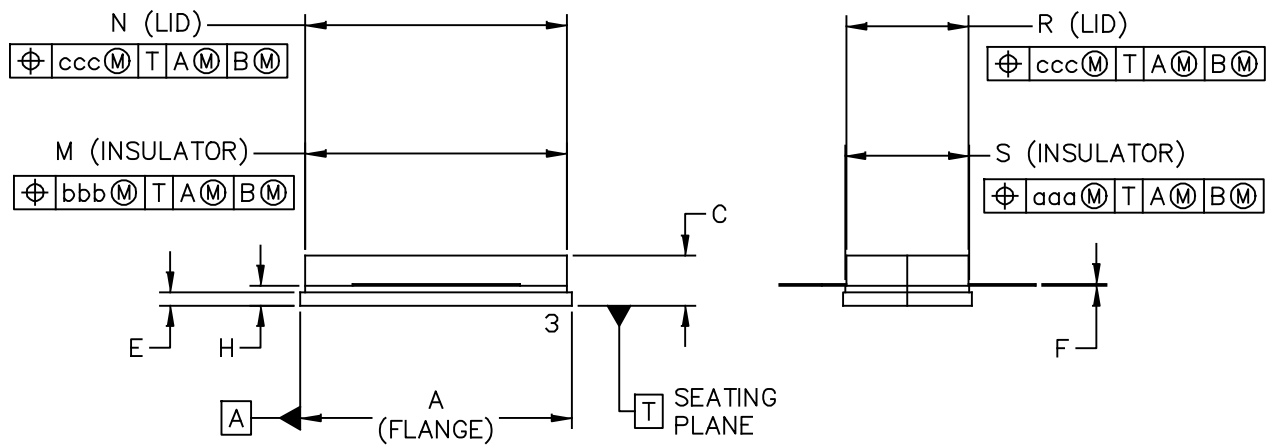
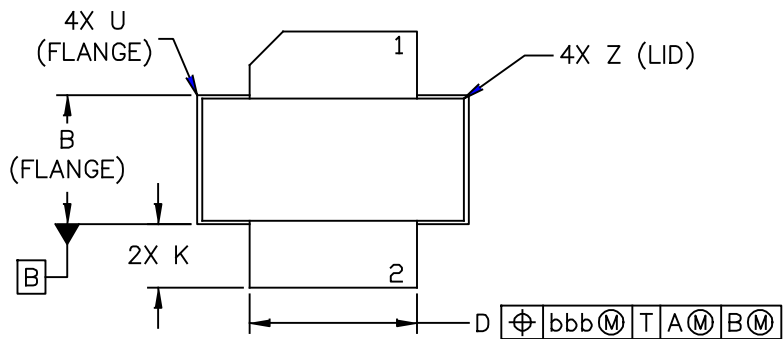
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M–1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED .030 (.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN  
2. GATE  
3. SOURCE

| DIM                                                     | INCH<br>MIN      MAX | MILLIMETER<br>MIN      MAX | DIM                      | INCH<br>MIN      MAX       | MILLIMETER<br>MIN      MAX |
|---------------------------------------------------------|----------------------|----------------------------|--------------------------|----------------------------|----------------------------|
| A                                                       | 1.335 – 1.345        | 33.91 – 34.16              | R                        | .365 – .375                | 9.27 – 9.53                |
| B                                                       | .380 – .390          | 9.65 – 9.91                | S                        | .365 – .375                | 9.27 – 9.52                |
| C                                                       | .125 – .170          | 3.18 – 4.32                | aaa                      | – .005 –                   | – 0.127 –                  |
| D                                                       | .495 – .505          | 12.57 – 12.83              | bbb                      | – .010 –                   | – 0.254 –                  |
| E                                                       | .035 – .045          | 0.89 – 1.14                | ccc                      | – .015 –                   | – 0.381 –                  |
| F                                                       | .003 – .006          | 0.08 – 0.15                | –                        | – – –                      | – – –                      |
| G                                                       | 1.100 BSC            | 27.94 BSC                  | –                        | – – –                      | – – –                      |
| H                                                       | .057 – .067          | 1.45 – 1.7                 | –                        | – – –                      | – – –                      |
| K                                                       | .170 – .210          | 4.32 – 5.33                | –                        | – – –                      | – – –                      |
| M                                                       | .774 – .786          | 19.66 – 19.96              | –                        | – – –                      | – – –                      |
| N                                                       | .772 – .788          | 19.6 – 20                  | –                        | – – –                      | – – –                      |
| Q                                                       | Ø.118 – Ø.138        | Ø3 – Ø3.51                 | –                        | – – –                      | – – –                      |
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|                                                         |                      |                            | CASE NUMBER: 465–06      |                            | 31 MAR 2005                |
|                                                         |                      |                            | STANDARD: NON–JEDEC      |                            |                            |



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|                                                         |  | CASE NUMBER: 465A-06     | 31 MAR 2005                |
|                                                         |  | STANDARD: NON-JEDEC      |                            |

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M—1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED .030 (0.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN
2. GATE
3. SOURCE

| INCH                                                    |      |        | MILLIMETER |                    |                          | INCH     |                            |             | MILLIMETER |  |  |
|---------------------------------------------------------|------|--------|------------|--------------------|--------------------------|----------|----------------------------|-------------|------------|--|--|
| DIM                                                     | MIN  | MAX    | MIN        | MAX                | DIM                      | MIN      | MAX                        | MIN         | MAX        |  |  |
| A                                                       | .805 | — .815 | 20.45      | — 20.7             | U                        | — — .040 |                            | — — 1.02    |            |  |  |
| B                                                       | .380 | — .390 | 9.65       | — 9.91             | Z                        | — — .030 |                            | — — 0.76    |            |  |  |
| C                                                       | .125 | — .170 | 3.18       | — 4.32             | aaa                      | — .005 — |                            | — 0.127 —   |            |  |  |
| D                                                       | .495 | — .505 | 12.57      | — 12.83            | bbb                      | — .010 — |                            | — 0.254 —   |            |  |  |
| E                                                       | .035 | — .045 | 0.89       | — 1.14             | ccc                      | — .015 — |                            | — 0.381 —   |            |  |  |
| F                                                       | .003 | — .006 | 0.08       | — 0.15             | —                        | — — —    |                            | — — —       |            |  |  |
| H                                                       | .057 | — .067 | 1.45       | — 1.7              | —                        | — — —    |                            | — — —       |            |  |  |
| K                                                       | .170 | — .210 | 4.32       | — 5.33             | —                        | — — —    |                            | — — —       |            |  |  |
| M                                                       | .774 | — .786 | 19.61      | — 20.02            | —                        | — — —    |                            | — — —       |            |  |  |
| N                                                       | .772 | — .788 | 19.61      | — 20.02            | —                        | — — —    |                            | — — —       |            |  |  |
| R                                                       | .365 | — .375 | 9.27       | — 9.53             | —                        | — — —    |                            | — — —       |            |  |  |
| S                                                       | .365 | — .375 | 9.27       | — 9.52             | —                        | — — —    |                            | — — —       |            |  |  |
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| TITLE:<br><br>NI—780S                                   |      |        |            |                    | DOCUMENT NO: 98ASB16718C |          |                            | REV: H      |            |  |  |
|                                                         |      |        |            |                    | CASE NUMBER: 465A—06     |          |                            | 31 MAR 2005 |            |  |  |
|                                                         |      |        |            |                    | STANDARD: NON—JEDEC      |          |                            |             |            |  |  |

## PRODUCT DOCUMENTATION AND SOFTWARE

Refer to the following resources to aid your design process.

### Application Notes

- AN1955: Thermal Measurement Methodology of RF Power Amplifiers

### Engineering Bulletins

- EB212: Using Data Sheet Impedances for RF LDMOS Devices

### Software

- Electromigration MTTF Calculator

For Software, do a Part Number search at <http://www.freescale.com>, and select the “Part Number” link. Go to the Software & Tools tab on the part’s Product Summary page to download the respective tool.

## REVISION HISTORY

The following table summarizes revisions to this document.

| Revision | Date      | Description                                                                       |
|----------|-----------|-----------------------------------------------------------------------------------|
| 0        | July 2014 | <ul style="list-style-type: none"> <li>• Initial Release of Data Sheet</li> </ul> |

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